

SD4833

POWER MOSFET

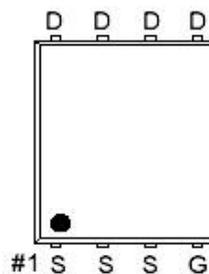
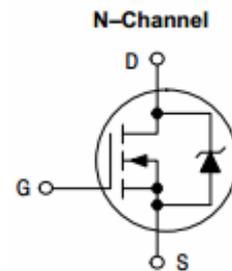
Description

The SD4833 is 195A N-Channel enhancement mode silicon gate power MOSFET uses advanced trench technology and to provide excellent $R_{DS(ON)}$ with low gate charge. This device is suitable for use in PWM, load switching, computer and general purpose applications.

Features

- Pb-free
- Fast switching capability
- $V_{DS}(V)=30V$
- $R_{DS(ON)}=2m\Omega @ V_{GS}=10V$
- $BV_{DSS}=30V$
- $I_D=195A$

Simplified Schematic



G. GATE
D. DRAIN
S. SOURCE

Maximum Ratings $T_A=25^\circ C$ unless otherwise specified

Characteristic	Symbol	Value	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current, $V_{GS}@10V$	I_D	$T_C=25^\circ C: 65$ $T_C=100^\circ C: 65$	A
Pulsed Drain Current	I_{DM}	300	A
Total Power Dissipation	P_D	$T_C=25^\circ C: 2.5$ Linear Derating Factor: $0.5W/^\circ C$	W
Single Pulse Avalanche Energy	E_{AS}	480	mJ
Storage Temperature Range	T_{STG}	-55 to 175	$^\circ C$
Operating Junction Temperature Range	T_J	-55 to 150	$^\circ C$

Thermal Characteristics

Characteristic	Symbol	Value	Units
Maximum Thermal Resistance, Junction-case	Rthj-c	3	°C/W
Maximum Thermal Resistance, Junction-ambient(PCB mount)	Rthj-a	45	°C/W

Electrical Characteristics $T_J=25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Drain-Source Breakdown Voltage	BV_{DSS}	30			V	$V_{GS}=0V, I_D=250\mu A$
Static Drain-Source On-Resistance	$R_{DS(ON)}$		1.6 2.8	2 3.2	m Ω	$V_{GS}=10V, I_D=30A$ $V_{GS}=4.5V, I_D=20A$
Gate Threshold Voltage	$V_{GS(th)}$	1		3	V	$V_{DS}=V_{GS}, I_D=250\mu A$
Forward Transconductance	g_{fss}		28		s	$V_{DS}=10V, I_D=30A$
Zero Gate Voltage Drain Current	I_{DSS}			1	μA	$V_{DS}=25V, V_{GS}=0V$
Gate-Body Leakage Current	I_{GSS}			\pm 100	nA	$V_{GS}=\pm 20V$
Total Gate Charge	Q_G			64	nC	$Q_g(10V): V_{GS}=10V, V_{DS}=12.5V, I_D=20A$
Gate-Source Charge	Q_{GS}		18		nC	$V_{GS}=10V, V_{DS}=12.5V, I_D=20A$
Gate-Drain Charge	Q_{GD}		6.8		nC	$V_{DS}=12.5V, V_{GS}=10V, I_D=20A$
Turn-On Delay Time	$t_{D(ON)}$		24		ns	$V_{DS}=12.5V, I_D=20A, R_G=3\Omega, R_L=0.6\Omega$
Rise Time			36		ns	$V_{DS}=12.5V, I_D=20A, R_G=3\Omega, R_L=0.6\Omega$
Turn-Off Delay Time	$t_{D(off)}$		19		ns	$V_{GS}=10V, V_{DS}=12.5V, R_L=0.68\Omega, R_{GEN}=3\Omega$
Fall Time	t_f		18		ns	$V_{GS}=10V, V_{DS}=12.5V, R_L=0.68\Omega, R_{GEN}=3\Omega$
Input Capacitance	C_{ISS}		4960		pF	$V_{DS}=12.5V, V_{GS}=0V, f=1MHz$
Output Capacitance	C_{OSS}		1320		pF	$V_{DS}=12.5V, V_{GS}=0V, f=1MHz$
Reverse Transfer Capacitance	C_{RSS}		680		pF	$V_{DS}=12.5V, V_{GS}=0V, f=1MHz$
Gate Resistance	R_g		0.68	1	Ω	$f=1MHz$

Source-Drain Diode

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward On Voltage	V_{SD}			1.2	V	$I_S=20A, V_{GS}=0V$
Reverse Recovery Time	T_{rr}		39		ns	$I_S=20A, V_{GS}=0V$
Reverse Recovery Charge	Q_{rr}		42		nC	$dI_{SD}/dt=100A/\mu s$

SD4833 TYPICAL CHARACTERISTICS

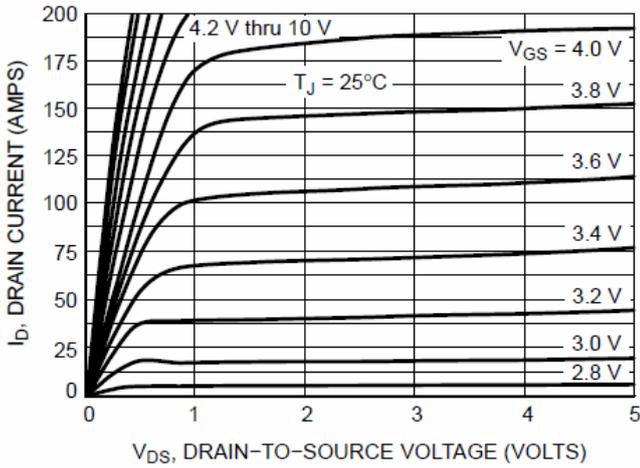


Figure 1. On-Region Characteristics

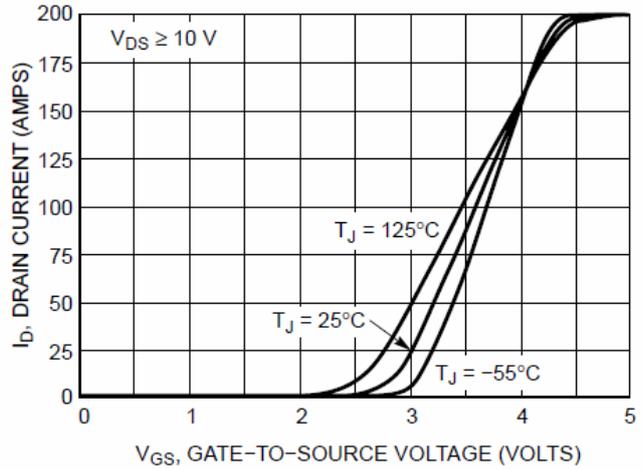


Figure 2. Transfer Characteristics

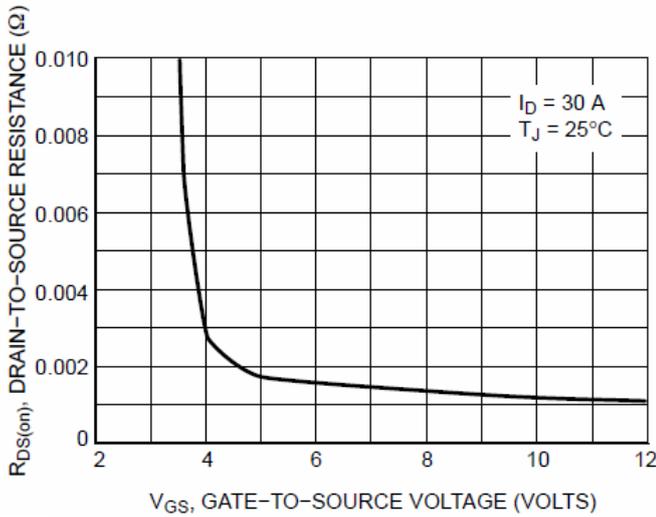


Figure 3. On-Resistance vs. Gate-to-Source Voltage

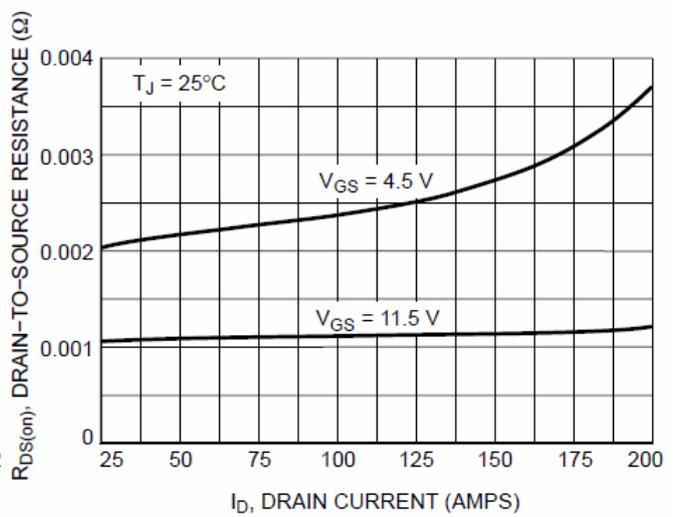
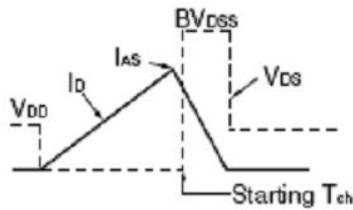
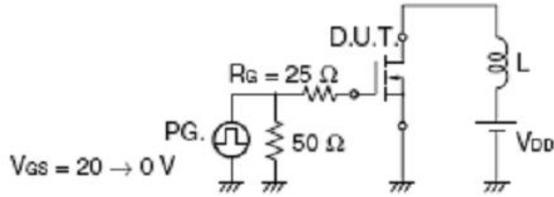
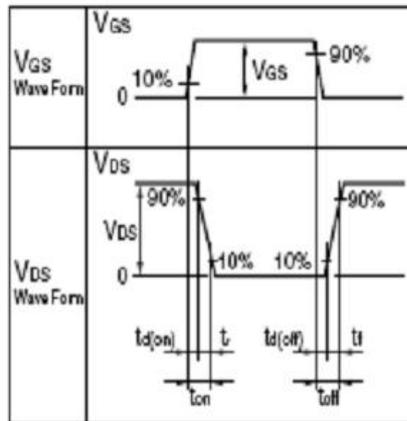
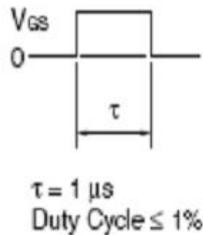
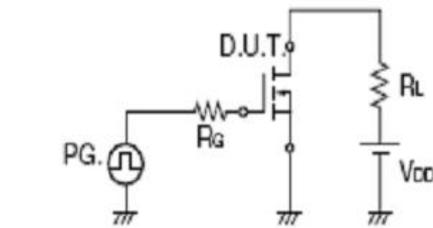


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

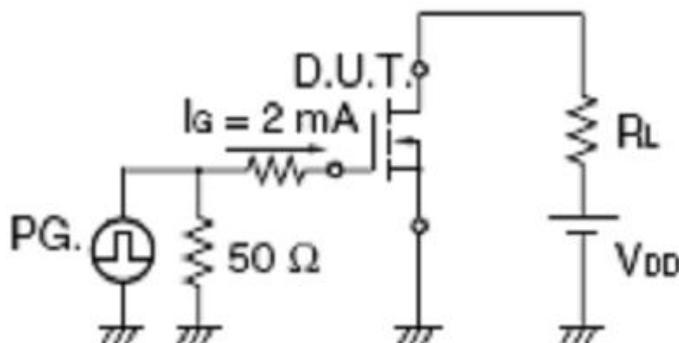
TEST CIRCUIT 1 AVALANCHE CAPABILITY



TEST CIRCUIT 1 SWITCHING TIME



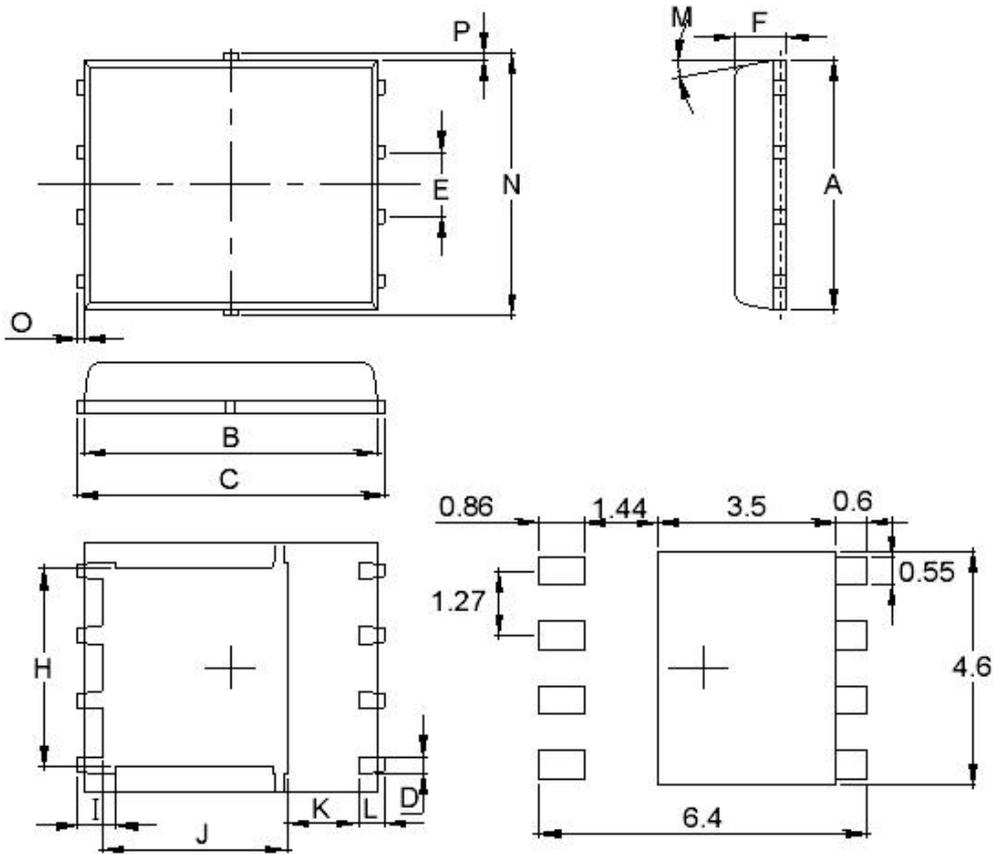
TEST CIRCUIT 3 GATE CHARGE



Package Dimension

PDFN 5x6P MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	4.8	4.9	5.1	I	0.35	0.53	0.71
B	5.7	5.75	5.825	J	3.34	3.56	3.78
C	5.9	6.0	6.1	K	1.1		
D	0.33	0.41	0.51	L	0.350	0.61	0.72
E		1.27		M	8°	10°	12°
F	0.8	1.0	1.2	N			5.3
G	0.17	0.25	0.34	O	0.05	0.1	0.20
H	3.67	3.85	4.02	P			0.1



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